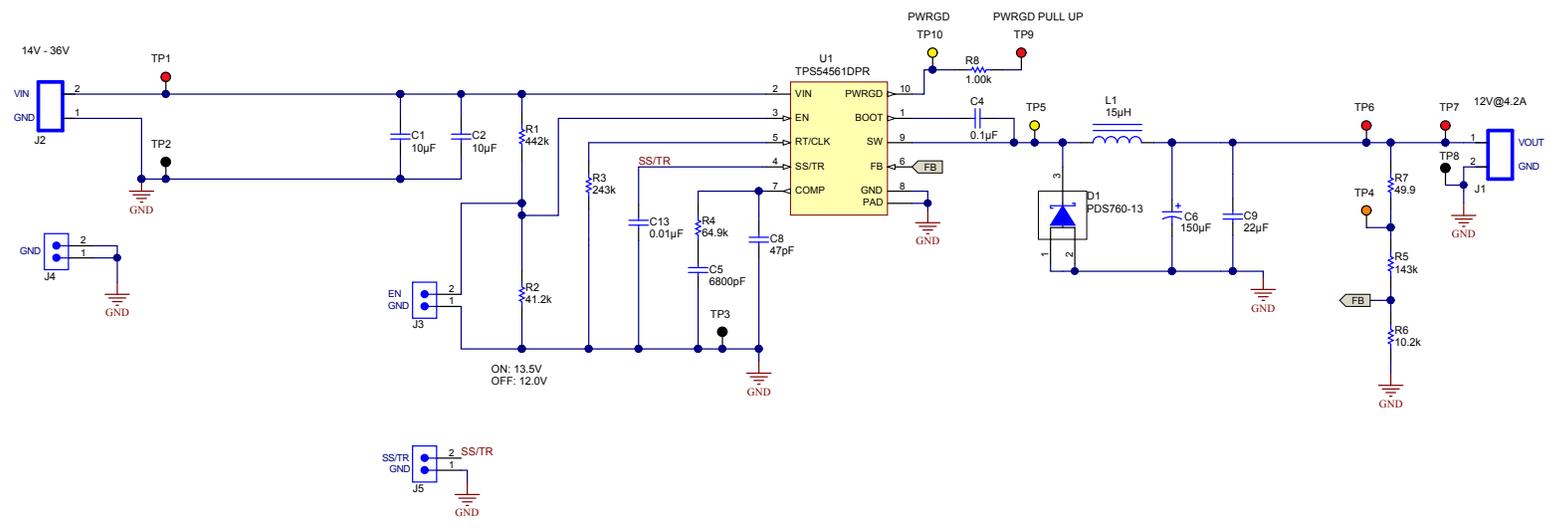


NOTES:
 1) Ref Des' match the TPS54561EVM-555 EVM.



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Designed for Public Release		Mod. Date: 11/11/2015	
Project Title: TPS54561 Buck Converter			
Number: PMP10357	Rev: B	Sheet Title:	
SVN Rev: Version control disabled	Assembly Variant: 001	Sheet: 1	of 1
Drawn By:	File: PMP10357 REV B.SchDoc	Size: B	
Engineer: J Betten	Contact: http://www.ti.com/support		



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